

# Board Stack Report

Stack Up		Layer Stack			
Layer	Board Layer Stack	Name	Material	Thickness	Constant
1		Top Paste			
2		Top Overlay			
3		Top Soldermask	Solder Resist	0.010mm	3.5
4		Top Layer	Copper	0.035mm	
5		Prepreg 7628-45		0.360mm	4.6
6		Mid1	Copper	0.036mm	
7		High Tg 1,08mm 35??m/35??m	FR-4	0.710mm	4.6
8		Mid2	Copper	0.036mm	
9		Prepreg 7628-45		0.360mm	4.6
10		Bottom Layer	Copper	0.035mm	
11		Bottom Soldermask	Solder Resist	0.010mm	3.5
12		Bottom Overlay			
13		Bottom Paste			
	Height : 1.592mm				